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PATENTS ONLY

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REC-4

U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office

Attorney Docket : 033036 M 117

1. Name of conveying party(ies):
Ken UKAWA
Hirofumi KURODA
Additional name of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: **Sumitomo Bakelite Co., Ltd.**
Street Address: **5-8, Higashi-Shinagawa 2-chome,
Shinagawa-ku, Tokyo 140-0002
JAPAN**
Additional Name(s) & address(es) attached? Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
Execution Date: **February 2, 2007**

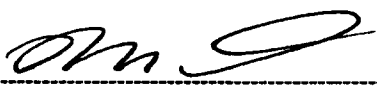
4. Application number(s) or patent number(s):
A. Patent Application No.(s)
Additional numbers attached? Yes No

This document is being filed together with a new application.
B. Patent No.(s)

5. Name and address of party to whom correspondence concerning this document should be mailed:
Name: **Michael A. Makuch**
Internal Address: **SMITH, GAMBRELL & RUSSELL, LLP**
03/06/2007 TNGUYEN2 00000033 11713598
04/FC:8021 40.00 OP
Street Address: **1850 M Street, NW - Suite 800**
City: **Washington** State: **DC** Zip: **20036**

6. Total number of applications and patents involved: - 1 -
7. Total fee (37 CFR 3.41) **\$40.00**
 Enclosed
 Authorized to be charged to deposit account
8. Deposit account number:
02-4300
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Michael A. Makuch  **March 5, 2007**

Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and documents: - 3 -
Mail documents to be recorded with required cover sheet information to:
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236590

PATENT
REEL: 019037 FRAME: 0854

Docket :

ASSIGNMENT

This assignment agreement is applicable to an invention entitled:

EPOXY RESIN COMPOSITION FOR ENCAPSULATING
SEMICONDUCTOR AND SEMICONDUCTOR DEVICE

THE PATENT RIGHTS referred to in this agreement are:

(check one)

- a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.
- U.S. patent application No. _____ filed _____
- a U.S. patent application based on PCT International Application No. _____ filed _____
(U.S. patent application Serial No. _____)
- U.S. patent No. _____ issued _____

THE PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

THE PATENT RIGHTS assigned under this agreement are:

(check one)

- U.S. patent rights only.
- Worldwide patent rights. (In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.)

THE ASSIGNORS referred to in this agreement are the inventors whose signatures appear on page 2 of this Assignment.

THE ASSIGNEE referred to in this agreement is:

(name and address)

Sumitomo Bakelite Co., Ltd.
5-8, Higashi-Shinagawa 2-chome, Shinagawa-ku, Tokyo 140-0002, JAPAN

THE ASSIGNEE is:

- An Individual.
- A Partnership.
- (state/country) A Corporation of Japan
- (other)

